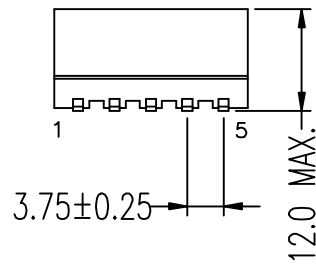
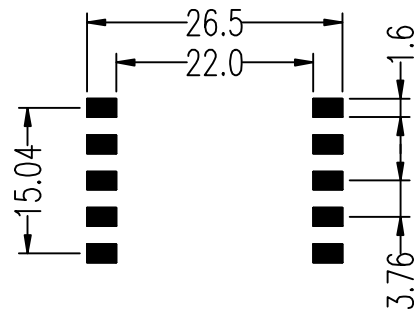


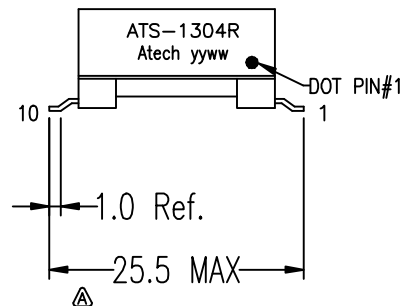
TOP VIEW



FRONT VIEW

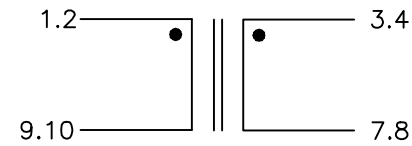


SUGGESTED LAND PATTERN




R-SIDE VIEW

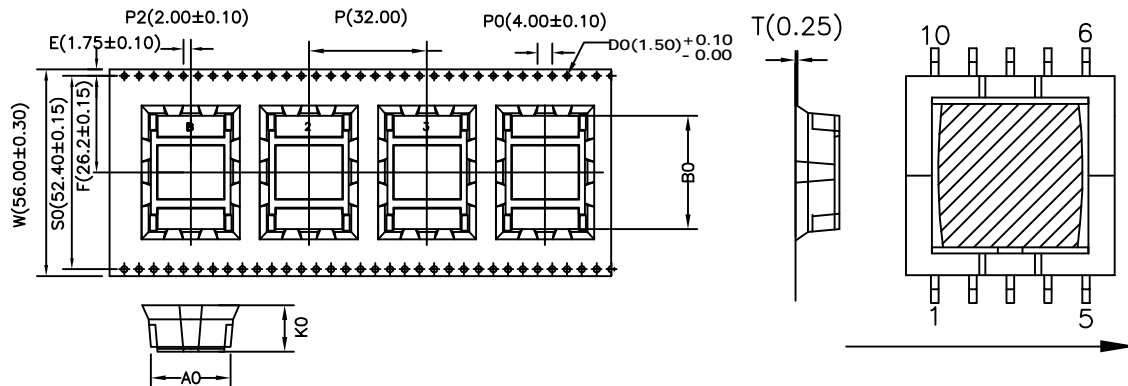
UNIT : mm



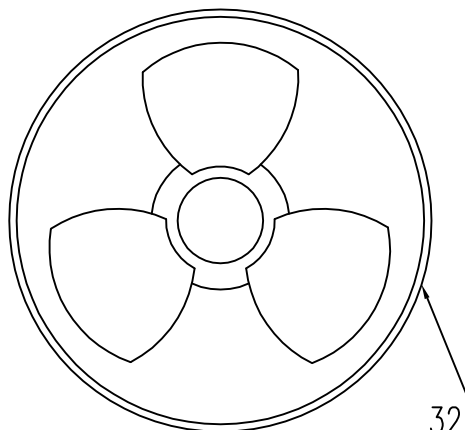
### ELECTRICAL CHARACTERISTICS :

- 1.DCR : PIN 1.2-9.10 = 67mΩ MAX.  
PIN 3.4-7.8 = 67mΩ MAX.
- 2.INDUCTANCE (@300KHz, 0.1Vrms)  
PIN 1-10 = PIN 2-9 = 100uH ±18%
- 3.LEAKAGE INDUCTANCE (@100KHz, 0.1Vrms)  
PIN 1.2-9.10 (PIN 3.4-7.8 SHORT) = 2.5uH MAX.
- 4.TURN RATIO (@100KHz, 0.1Vrms) :  
PIN 1.2 - 9.10 : PIN 3.4 - 7.8 = 1.0 ±2%
- 5.HI-POT :  
(@1500VAC, 1.0mA, 2SEC) PIN 1.2-3.4
- 6.RoHS Compliance

								TITLE POWER TRANSFORMER	
								DWG. NO. ATS-1304R	
A	CHANGE DIM.	06/08/2021	SHIRLEY	BETTY	BETTY	UNITS: M/M		SAFETY	
	RELEASE	12/10/2013	SHIRLEY	RONAN	RONAN	DATE 12/10/13		SHEET 1 OF 1	
NO:	DESCRIPTION	DATE	BY	CHK	APPD	P/N:		DRAW Shirley	
REVISIONS									



ITEM	W	AO	BO	K0	P	F	E	D0	D1	P0	P2	T
DIM	56.0 <sup>+0.3</sup> <sub>-0.3</sub>	23.0 <sup>+0.1</sup> <sub>-0.1</sub>	29.5 <sup>+0.1</sup> <sub>-0.1</sub>	12.0 <sup>+0.1</sup> <sub>-0.1</sub>	32.0 <sup>+0.1</sup> <sub>-0.1</sub>	26.2 <sup>+0.1</sup> <sub>-0.1</sub>	1.75 <sup>+0.1</sup> <sub>-0.1</sub>	1.5 <sup>+0.10</sup> <sub>-0.0</sub>	0.00 <sup>+0.1</sup> <sub>-0.00</sub>	4.0 <sup>+0.1</sup> <sub>-0.1</sub>	2.0 <sup>+0.1</sup> <sub>-0.1</sub>	0.5 <sup>+0.05</sup> <sub>-0.05</sub>



3260560005\*2SET

卷带前空格为13格，结尾空格为8格。

ONE REEL:150PCS

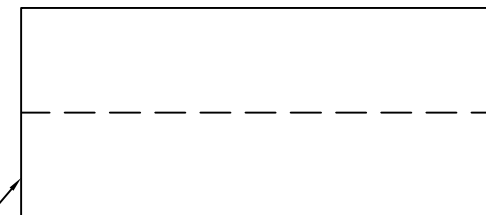
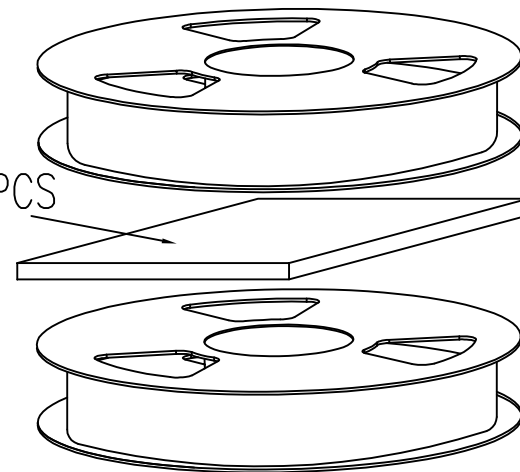
ONE CARTON:2 REEL (300PCS)

每卷放1包干燥剂 (2780000000)

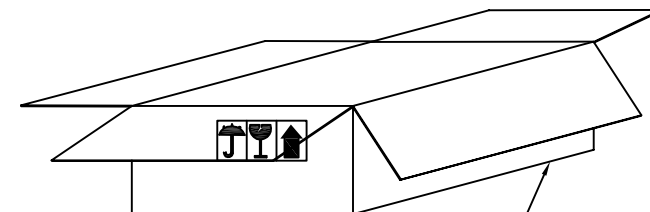
每卷用真空袋抽真空封口 (3255048422)

卷带外围围上一层黑色的保护带。Ⓐ


PK-045\*1PCS  
3240300009



将3240300010一分为二裁切后放置在纸箱四周

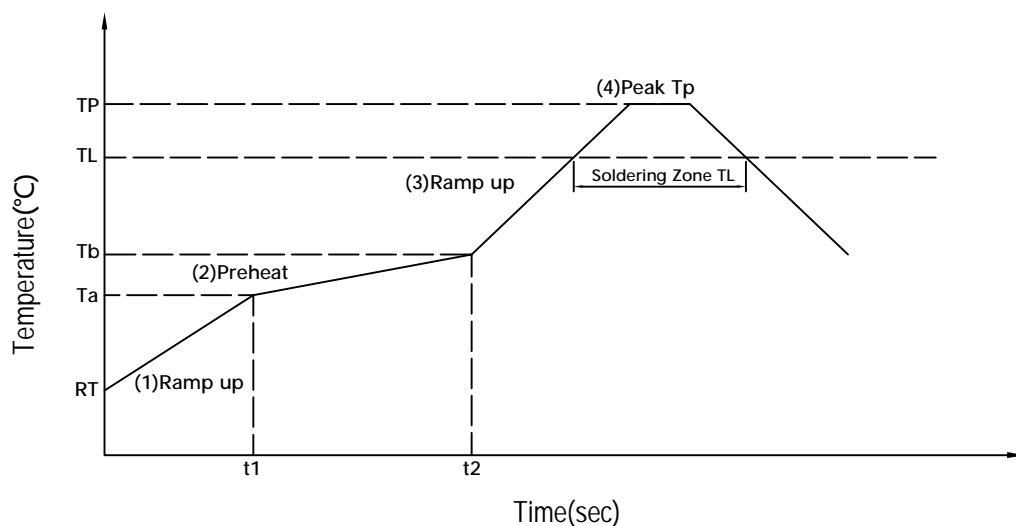


PK-071A\*1PCS  
3213434003

							TITLE	
							REEL PACKING	
							DWG. NO.	
A	Delete humidity card	11/27/2023	Wang	Wang	Dai		968SE88100	
	RELEASE	01/08/2018	Wang	Wang	Dai	UNITS:	SAFETY	
						M/M		
NO:	DESCRIPTION	DATE	BY	CHK	APPD	DATE	P/N:	SHEET 1 OF 1
REVISIONS						01/08/2018		汪诗梅



## Pb-free Soldering IR Reflow(SMD)



- 1,MSL Grade: 1 Level      2,Floor life: 2years      3,Condition:≤30°C RH 85%  
2,Form-1(Reference JEDEC J-STD-020D Table 5-2)

IR reflow profile		Pb-free
step#	Profile Feature	Condition/Duration
step1	Ramp-up rate	3°C/second max
step2	Preheat:150°C-200°C(Ta-Tb)	t1-t2:60-120seconds
step3	Ramp-up rate(TL to Tp)	3°C/second max
	Temperature maintained above 217°C	60-150seconds
step4	Peak temperature(Tp)	260+0/-5°C
	Time within 5°C of actual peak temperature	30seconds max
Ramp-down rate(Tp to TL)		6°C/second max

- 3,Form-2(Reference JEDEC J-STD-020D Table 4-2)

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
<1.6mm	260+0/-5°C	260+0/-5°C	260+0/-5°C
1.6mm-2.5mm	260+0/-5°C	250+0/-5°C	245+0/-5°C
>2.5mm	250+0/-5°C	245+0/-5°C	245+0/-5°C